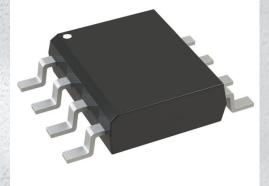


DMN3015LSD-13 Datasheet

www.digi-electronics.com



DiGi Electronics Part Number Manufacturer Manufacturer Product Number Description Detailed Description DMN3015LSD-13-DG **Diodes Incorporated** DMN3015LSD-13 MOSFET 2N-CH 30V 8.4A 8SO Mosfet Array 30V 8.4A (Ta) 1.2W Surface Mount 8-S O

https://www.DiGi-Electronics.com



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Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
DMN3015LSD-13	Diodes Incorporated
Series:	Product Status:
-	Active
Technology:	Configuration:
MOSFET (Metal Oxide)	2 N-Channel (Dual)
FET Feature:	Drain to Source Voltage (Vdss):
-	30V
Current - Continuous Drain (ld) @ 25°C:	Rds On (Max) @ ld, Vgs:
8.4A (Ta)	15mOhm @ 12A, 10V
Vgs(th) (Max) @ ld:	Gate Charge (Qg) (Max) @ Vgs:
2.5V @ 250µA	25.1nC @ 10V
Input Capacitance (Ciss) (Max) @ Vds:	Power - Max:
1415pF @ 15V	1.2W
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Surface Mount
Package / Case:	Supplier Device Package:
8-SOIC (0.154", 3.90mm Width)	8-SO
Base Product Number:	
DMN3015	

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8541.29.0095	





DMN3015LSD

Product Summary

V _{(BR)DSS}	R _{DS(on) max}	Ι _D T _A = +25°C
2017	15mΩ @ V _{GS} = 10V	8.4A
30V	18mΩ @ V _{GS} = 4.5V	7.7A

Description

This new generation MOSFET has been designed to minimize the onstate resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- **DC-DC Converters**
- **Power Management Functions**
- Backlighting

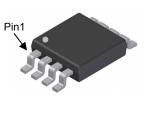
30V DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

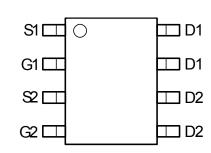
Features and Benefits

- Low Input Capacitance
- Low On-Resistance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

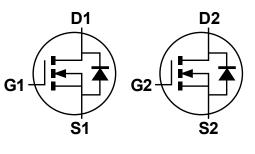
Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Tin Finish annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.074 grams (approximate)





Top View



Pin Configuration



Ordering Information (Note 4)

Top View

Part Number	Case	Packaging
DMN3015LSD-13	SO-8	2,500/Tape & Reel

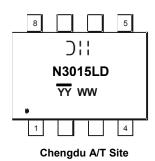
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. Notes:

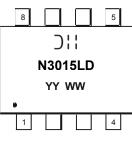
2. See http://www.diodes.com/quality/lead free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information





Shanghai A/T Site

Characteria Control Contro N3015LD = Product Type Marking Code YYWW = Date Code Marking YY or \overline{YY} = Year (ex: 14 = 2014) WW = Week (01 - 53) YY = Date Code Marking for SAT (Shanghai Assembly/ Test site) YY = Date Code Marking for CAT (Chengdu Assembly/ Test site)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic Drain-Source Voltage			Symbol	Value	Units
			V _{DSS}	30	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Durin Current (Nate C) / - 40/	Steady State	T _A = +25°C T _A = +70°C	۱ _D	8.4 6.8	А
Continuous Drain Current (Note 6) V _{GS} = 10V	t<10s	T _A = +25°C T _A = +70°C	I _D	11.0 9.0	А
Maximum Body Diode Forward Current (Note 6)			ls	2.5	A
Pulsed Drain Current (10µs pulse, duty cycle = 1%)			I _{DM}	80	А
Avalanche Current (Notes 7) L = 0.1mH			I _{AS}	22	А
Avalanche Energy (Notes 7) L = 0.1mH			E _{AS}	25	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units
Total Power Dissipation (Note 5)	T _A = +25°C	Р	1.2	W
Total Power Dissipation (Note 5)	T _A = +70°C	P _D	0.8	vv
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	R _{0JA}	102	°C/W
Thermal Resistance, Junction to Amblent (Note 5)	t<10s		62	
Total Dower Dissinction (Note 6)	T _A = +25°C	P _D	1.6	W
Total Power Dissipation (Note 6)	T _A = +70°C		1.0	
Thermal Desistance Junction to Ambient (Note 6)	Steady state	D	78	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	47	
Thermal Resistance, Junction to Case (Note 6)		R _{θJC}	14.5	
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symphol	Min	T. m	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)	Symbol	WIIN	Тур	Max	Unit	Test Condition	
		20			V		
Drain-Source Breakdown Voltage	BV _{DSS}	30			V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	—	1	μA	$V_{DS} = 30V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	—	±100	nA	V_{GS} = ±20V, V_{DS} = 0V	
ON CHARACTERISTICS (Note 8)					·	1	
Gate Threshold Voltage	V _{GS(TH)}	1.3		2.5	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance	Research	_	8	15	mΩ	V _{GS} = 10V, I _D = 12A	
	R _{DS(ON)}	—	12	18	11152	V _{GS} = 4.5V, I _D = 10A	
Diode Forward Voltage	V _{SD}	_	0.7	1.0	V	$V_{GS} = 0V, I_S = 1A$	
DYNAMIC CHARACTERISTICS (Note 9)			÷				
Input Capacitance	C _{iss}	_	1415	_		V _{DS} = 15V, V _{GS} = 0V, f = 1.0MHz	
Output Capacitance	Coss	—	119	_	pF		
Reverse Transfer Capacitance	C _{rss}	_	82	_			
Gate Resistance	R _G	_	2.6	3.2	Ω	V _{DS} = 0V, V _{GS} = 0V, f = 1.0MHz	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	11.3	_			
Total Gate Charge (V _{GS} = 10V)	Qg	_	25.1	_	nC		
Gate-Source Charge	Q _{gs}	_	3.5	_	nc	V _{DS} = 15V, I _D = 12A	
Gate-Drain Charge	Q _{gd}	_	3.6	_			
Turn-On Delay Time	t _{D(on)}	_	4.8	_			
Turn-On Rise Time	tr	_	16.5	_	-0	V _{DD} = 15V, V _{GS} = 10V, R _L = 1.25Ω, R _G = 3Ω,	
Turn-Off Delay Time	t _{D(off)}	_	26.1	_	nS		
Turn-Off Fall Time	tf		5.6	_]		
Body Diode Reverse Recovery Time	t _{rr}		8.5		nS	I _S = 12A, dI/dt = 500A/µs	
Body Diode Reverse Recovery Charge	Qrr	_	7.0	_	nC	I _S = 12A, dI/dt = 500A/µs	

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. Notes:

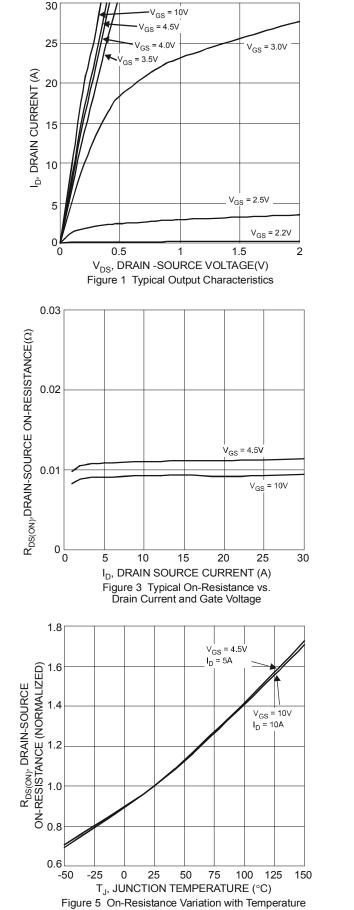
7. UIS in production with L = 0.1mH, starting $T_A = +25^{\circ}$ C.

8. Short duration pulse test used to minimize self-heating effect.

9. Guaranteed by design. Not subject to product testing.



DMN3015LSD



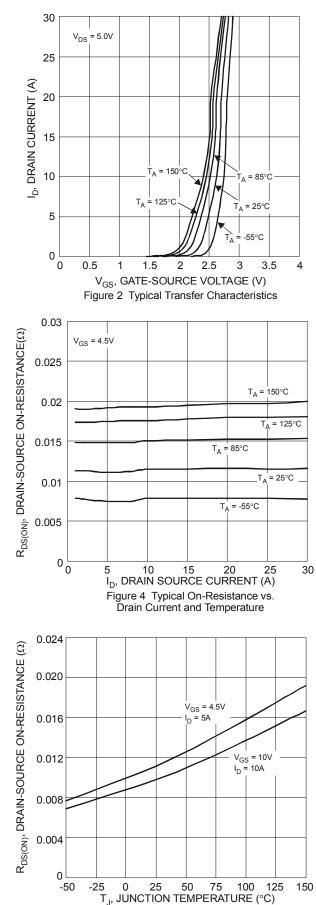
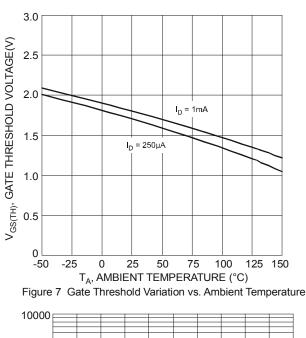


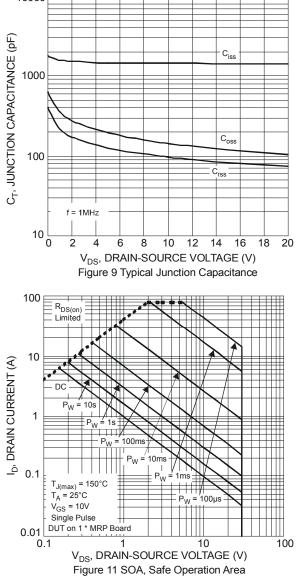
Figure 6 On-Resistance Variation with Temperature

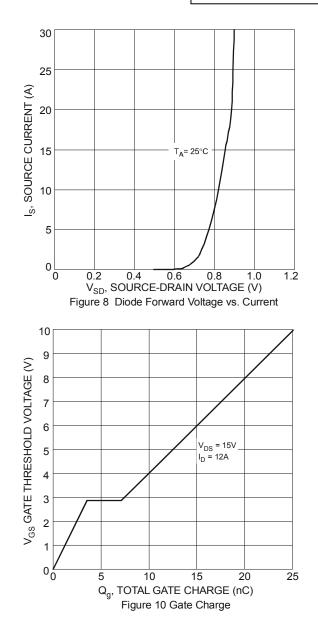


NEW PRODUCT

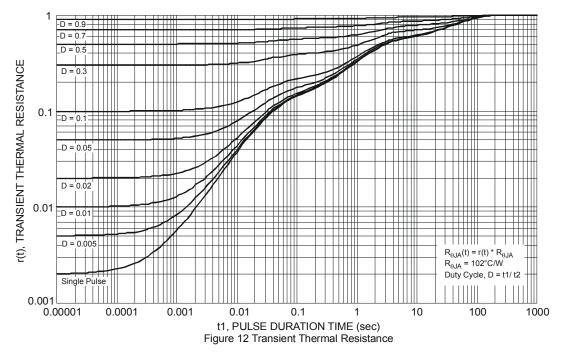
DMN3015LSD





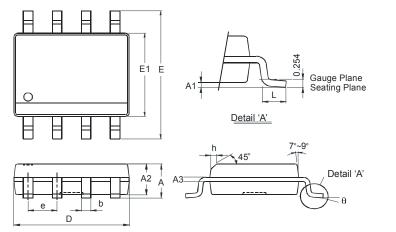






Package Outline Dimensions

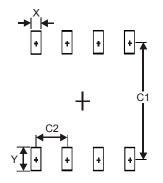
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



	SO-8				
Dim	Min	Max			
Α	-	1.75			
A1	0.10	0.20			
A2	1.30	1.50			
A3	0.15	0.25			
b	0.3	0.5			
D	4.85	4.95			
E	5.90	6.10			
E1	3.85	3.95			
е	1.27 Typ				
h	-	0.35			
L	0.62	0.82			
θ	0°	8°			
All Di	mensions	in mm			

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
X	0.60
Y	1.55
C1	5.4
C2	1.27



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